

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Wen-Hsiung Yang</td> <td>08/19/2012</td> </tr> <tr> <td>Shih-Huai Cho</td> <td>08/19/2012</td> </tr> <tr> <td>Hua Chen</td> <td>08/19/2012</td> </tr> </tbody> </table>		Name	Execution Date	Wen-Hsiung Yang	08/19/2012	Shih-Huai Cho	08/19/2012	Hua Chen	08/19/2012
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<table border="1"> <tr> <td>Name:</td> <td>Wistron Corporation</td> </tr> <tr> <td>Street Address:</td> <td>21F, 88, Sec. 1, Hsin-Tai-Wu Rd., Xizhi Dist.</td> </tr> <tr> <td>City:</td> <td>New Taipei City</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	Wistron Corporation	Street Address:	21F, 88, Sec. 1, Hsin-Tai-Wu Rd., Xizhi Dist.	City:	New Taipei City	State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1									
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CORRESPONDENCE DATA									
<p>Fax Number: 7039974517 Phone: 3027291562 Email: Patent.admin.uspto.cr@naipo.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i> Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506 Address Line 4: Merrifield, VIRGINIA 22116</p>									
ATTORNEY DOCKET NUMBER:	WISP0782USA								
NAME OF SUBMITTER:	SIBYL YU								
Total Attachments: 2 source=1443781#page1.tif source=1443781#page2.tif									

CH \$40.00 13590136

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Wen-Hsiung Yang Nationality: TW

Name: Shih-Huai Cho Nationality: TW

Name: Hua Chen Nationality: TW

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: Wistron Corporation

Address: 21F, 88, Sec. 1, Hsin-Tai-Wu Rd., Xizhi Dist., New Taipei City 221, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"HEAT DISSIPATING MODULE HAVING ENHANCED HEAT DISSIPATING
EFFICIENCY"

Which is found in :

- (a) + U.S. patent application executed on even date
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____
- (e) _____ International application no. _____

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this AUG 19 2012 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Wen-Hsiung Yang

Wen Hsiung, Yang

Shih-Huai Cho

Shih-Huai Cho

Hua Chen

Hua Chen